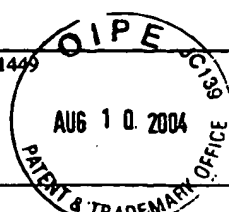


## PATENT APPLICATION

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ATTY. DKT NO. 01-103-CON3

SER. NO. 10/699,837

APPLICANT MAMITSU et al.

FILING DATE November 4, 2003

GROUP 2822

## REFERENCE DESIGNATION

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS

## FOREIGN PATENT DOCUMENTS

## TRANSLATION


	DOCUMENT NUMBER	DATE	COUNTRY	NAME	CLASS	SUB CLASS	YES	NO
<i>AA</i>	JP-A-10-125700	05/15/98	JAPAN				Engl. Abstract	
<i>BB</i>	JP-A-61-147539	07/05/86	JAPAN				Engl. Abstract	

\* Full English text of the JP Document will be available in machine-translated form from JP (Japanese Patent Office) English language web site at <http://www1.ipdl.jpo.go.jp/PA1/cgi-bin/PA1INDEX>.

## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

EXAMINER	DATE CONSIDERED	
<i>[Signature]</i>	12/11/04	

Rev. 10/94 (Form 3.05)

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# REFERENCE DESIGNATION

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS
<i>SP</i>	4,620,215	Oct., 1986	Lee, James C.K.		
<i>SP</i>	6,472,305	Oct., 2002	Ozaki et al.		


## FOREIGN PATENT DOCUMENTS

								TRANSLATION	
		DOCUMENT NUMBER	DATE	COUNTRY	NAME	CLASS	SUB CLASS	YES	NO (Abstract)

\* Full English text of the JP Document will be available in machine-translated form from JP (Japanese Patent Office) English language web site at <http://www1.ipdl.jpo.go.jp/PA1/cgi-bin/PA1INDEX>.

## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

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## FOREIGN PATENT DOCUMENTS

								TRANSLATION	
		DOCUMENT NUMBER	DATE	COUNTRY	NAME	CLASS	SUB CLASS	YES	NO (Abstract)
<i>AB</i>		JP-A-H07-66143	3/10/95	JAPAN					X
<i>AB</i>		JP-A-H09-237868	9/9/97	JAPAN					X
<i>AB</i>		JP-A-H09-45773	2/14/97	JAPAN					X
<i>AB</i>		JP-A-H11-204803	7/30/99	JAPAN					X

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## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

EXAMINER	<i>[Signature]</i>	DATE CONSIDERED 12/11/04